



Schottky Diodes

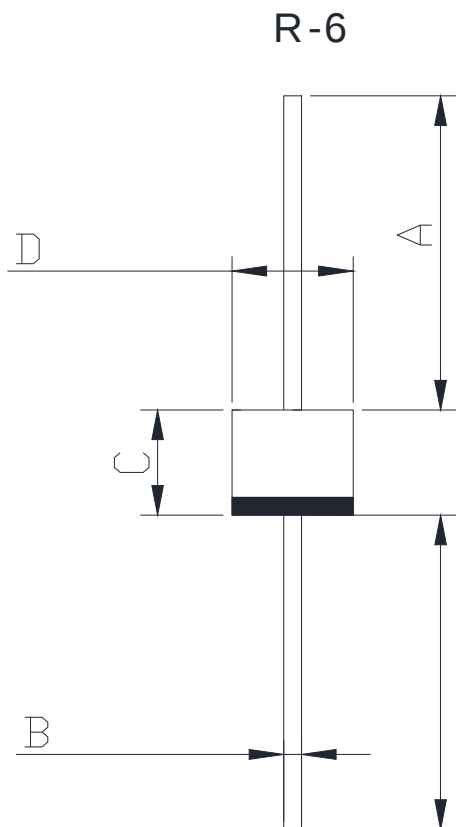
Features

- High frequency operation
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7s, per JESD 22-B106

Typical Applications



■Outline Dimensions



R-6		
Dim	Min	Max
A	25.4	/
B	1.2	1.3
C	8.6	9.1
D	8.6	9.1



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